

2027 Asia-Pacific International Symposium on Electromagnetic Compatibility

May 17-20

Jeju Island, Republic of Korea

ABOUT THE SYMPOSIUM

The 2027 Asia-Pacific International Symposium on Electromagnetic Compatibility (APEMC 2027) will be held at the Grand Hyatt Jeju in Jeju Island, Republic of Korea, from May 17 to 20, 2027. The symposium aims to share recent advances in all aspects of EMC in the Asia-Pacific region, to respond to the EMC requirements for all rising technologies, and to link up the international EMC community closely. We warmly invite all prospective authors and experts to submit original papers on their latest research findings and outcomes. We also welcome proposals for focused sessions, industrial forums, workshops, and tutorials.

SYMPOSIUM TOPICS

- EMC Management and Standards
- EMC Measurements and Instrumentation
- Electromagnetic Environment and Low Frequency EMC
- Transient EMC and High Power Electromagnetics
- Power System EMC, Smart Grid, and Power Electronics
- System-Level EMC and Protection
- Transportation and Aerospace EMC
- Antenna and Wave Propagation
- IC and Electronic Packaging EMC
- Signal and Power Integrity (SI/PI)
- EMC in Emerging Wireless Technologies (5G/6G, IoT, WPT)
- Computational Electromagnetics & Multiphysics
- Biomedical Electromagnetics & EMF Safety
- Nanotechnology and Advanced Materials for EMC
- Artificial Intelligence (AI) in EMC
- Others

IMPORTANT DATES

- Proposal for Special Session
- Proposal for Workshop & Tutorial
- Regular Paper Submission*
- Notification of Acceptance
- Final Manuscript Submission

October 16, 2026

October 16, 2026

November 30, 2026

February 01, 2027

February 16, 2027



APEMC 2027
JEJU, KOREA

* Authors have options to submit a full-length paper (3-4 pages) or a 1-page abstract.

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PAPER SUBMISSION

All papers must be submitted electronically in a two-column format, as either a one-page abstract (for proceedings only) or a three-to-four-page regular paper (for IEEE Xplore publication). Submissions must be made in PDF format through the APEMC 2027 website (www.apemc2027.org), and hardcopy submissions will not be accepted. A Microsoft Word template will be available on the symposium website. All submitted manuscripts must be camera-ready and compliant with general IEEE standards.

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